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(54) **DISPLAY SUBSTRATE, PREPARING METHOD THEREOF, AND DISPLAY APPARATUS**

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(57) **ABSTRACT**

A display substrate includes a display area and a bonding area located on one side of the display area; the display substrate includes a base substrate and a circuit structure layer disposed on the base substrate; the circuit structure layer of the display area is provided with a pixel driving circuit including multiple transistors, the display area further includes a light emitting structure layer and a package structure layer sequentially stacked on a side of the circuit structure layer away from the base substrate, the light emitting structure layer includes a light emitting device connected to the pixel driving circuit; a pad is provided in the circuit structure layer of the bonding area and configured to be bonded and connected to an external circuit board, a surface of the pad is disposed flush with a surface of the circuit structure layer around the pad and away from the base substrate.

